LCD Module Technical Specification

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Apr 13, 2012

Type No. F-51320GNY-LY-AFN

Customer : **STANDARD**

Customer's Product No: -----

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V.	on History Date	Page	Comment	
	May 9, 2008	24~26	Revise of Precautions Relating Product Handli and Warranty.	ng
	Apr. 13. 2012	_	Changing company's name	
			January Company	

1. General Specifications

Operating Temp. : min. 0°C ~max. 50°C

Storage Temp. : min. -20°C ~max. 70°C

Dot Pixels : 128 (W) \times 64 (H) dots

Dot Size : $0.48 \text{ (W)} \times 0.48 \text{ (H)} \text{ mm}$

Dot Pitch : $0.50 \text{ (W)} \times 0.50 \text{ (H)} \text{ mm}$

Viewing Area : $66.8 \text{ (W)} \times 35.5 \text{ (H)} \text{ mm}$

Outline Dimensions : 89.7 (W) \times 49.8* (H) \times (11.8)** (D) mm

* Without FPCUV

** Without Fook of LED Backlight

Weight : 43.5g max.

LCD Type : NTD-20526

(STN / Yellow-mode / Transmissive)

Viewing Angle : 6:00

Data Transfer : 8-bit parallel data transfer

Backlight : LED Backlight / Yellow-green

Drawings : Dimensional Outline UE-310360C

RoHS regulation : To our best knowledge, this product satisfies material

requirement of RoHS regulation.

Our company is doing the best efforts to obtain the equivalent certificate from our suppliers.

2. Electrical Specifications

2.1.Absolute Maximum Ratings

GND=0V

Parameter	Symbol	Conditions	Min.	Max.	Units
Supply Voltage	V _{DD-} GND	-	-0.3	7.0	V
(Logic)					
Supply Voltage	V _{DD-} GND	With Triple (In case of 5V)	-6.0	+0.3	V
(Booster Circuit)		With Quad (In case of 3V)	-4.5	+0.3	
Supply Voltage 1	V_{5},V_{OUT}	-	-18.0	+0.3	V
(LCD Drive)					
Input Voltage	VIN	-	-0.3	V _{DD} +0.3	V

2.2.DC Characteristics

Ta=25°C, GND=0V

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Supply Voltage	V _{DD-} GND	With Triple	4.5	-	5.5	V
(Logic)		With Quad	2.7	-	3.3	
Supply Voltage	V _{DD-} V ₅		Shown in 3.	1		V
(LCD Drive)						
"High" Level	Vн	-	$0.8 \times V_{DD}$	-	V _{DD}	V
Input Voltage						
"Low" Level	Vı∟	-	GND	-	$0.2 \times V_{DD}$	V
Input Voltage						
"High" Level	Vон	Iон=-0.1mA	0.8×V _{DD}	-	V _{DD}	V
Output Voltage						
"Low" Level	Vol	loL=0.1mA	GND	-	$0.2 \times V_{DD}$	V
Output Voltage						
Supply Current	IDD	V _{DD} -GND=5.0V	-	1.08	1.62	mA

2.3.AC Characteristics

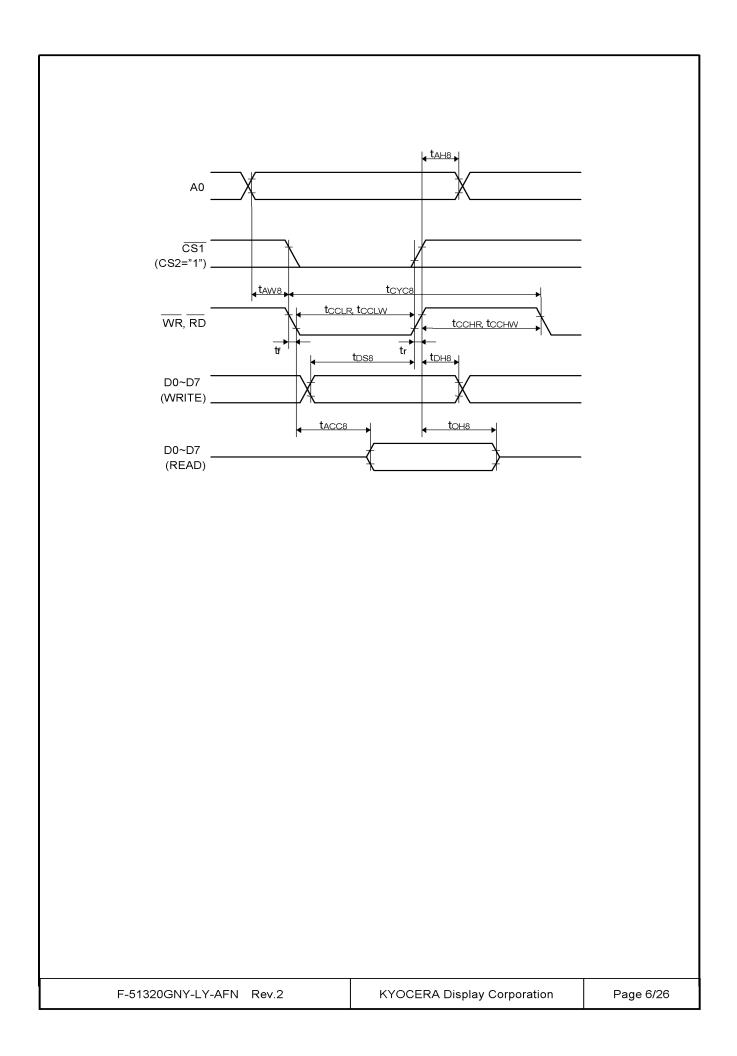
2.3.1.Read/Write Operation Sequence (80 series CPU)

 $V_{DD}\text{=}5.0V{\pm}10\%$

Parameter		Symbol	Min.	Max.	Units
Address Setup Time		t _{AW8}	0	-	ns
Address Hold Time		t _{AH8}	0	-	ns
System Cycle Time		t _{CYC8}	166	-	ns
Control Low Pulse Width	WRITE	t _{cclw}	30	-	ns
	READ	t _{CCLR}	70	-	ns
Control High Pulse Width	WRITE	t _{cchw}	30	-	ns
	READ	t _{cchr}	30	-	ns
Data Setup Time		t _{DS8}	30	-	ns
Data Hold Time		t _{DH8}	10	-	ns
RD Access Time		t _{ACC8}	_	70	ns
Output Disable Time		t _{OH8}	5	50	ns

V_{DD}=2.7~4.5V

Parameter		Symbol	Min.	Max.	Units		
Address Setup Time		t _{AW8}	0	-	ns		
Address Hold Time		t _{AH8}	0	-	ns		
System Cycle Time		t _{CYC8}	300	-	ns		
Control Low Pulse Width	WRITE	tcclw	60	-	ns		
	READ	t _{CCLR}	120	-	ns		
Control High Pulse Width	WRITE	t _{cchw}	60	-	ns		
	READ	tcchr	60	-	ns		
Data Setup Time		t _{DS8}	40	-	ns		
Data Hold Time		t _{DH8}	15	-	ns		
RD Access Time (CL=100pF)		t _{ACC8}	-	140	ns		
Output Disable Time		t _{OH8}	10	100	ns		



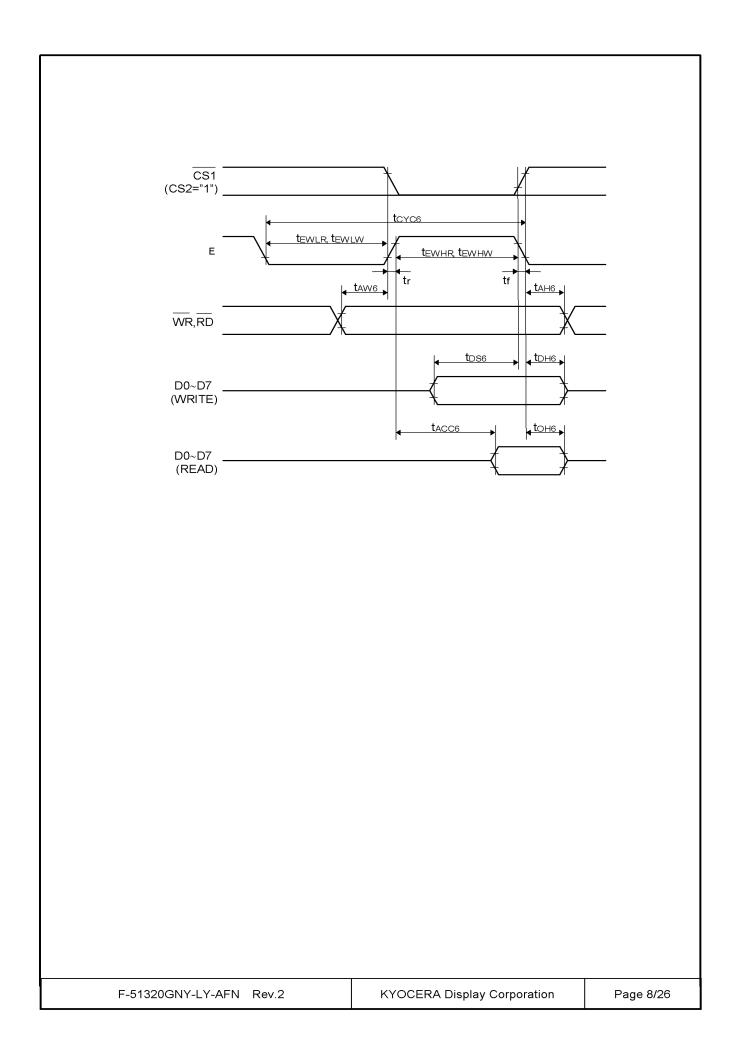
2.3.2.Read/Write Operation Sequence (68 series CPU)

V_{DD} =5.0V±10%

Parameter		Symbol	Min.	Max.	Units
Address Setup Time		t _{AH6}	0	-	ns
Address Hold Time		t _{AW6}	0	-	ns
System Cycle Time		t _{CYC6}	166	-	ns
Data Setup Time		t _{DS6}	30	-	ns
Data Hold Time		t _{DH6}	10	-	ns
Access Time (CL=100pF)	Access Time (CL=100pF)		-	70	ns
Output Disable Time	Output Disable Time		10	50	ns
Enable High Pulse Width	READ	t _{EWHR}	70	-	ns
	WRITE	t _{EWHW}	30	-	ns
Enable Low Pulse Width	READ	t _{EWLR}	30	-	ns
	WRITE	t _{EWLW}	30	_	ns

V_{DD}=2.7~4.5V

Parameter		Symbol	Min.	Max.	Units
Address Setup Time		t _{AH6}	0	-	ns
Address Hold Time		t _{AW6}	0	-	ns
System Cycle Time		t _{CYC6}	300	-	ns
Data Setup Time		t _{DS6}	40	-	ns
Data Hold Time		t _{DH6}	15	-	ns
Access Time (CL=100pF)	Access Time (CL=100pF)		_	140	ns
Output Disable Time		t _{OH6}	10	100	ns
Enable High Pulse Width	READ	t ewhr	120	-	ns
	WRITE	t _{EWHW}	60	-	ns
Enable Low Pulse Width	READ	t _{EWLR}	60	-	ns
	WRITE	t _{EWLW}	60	-	ns



2.3.3. Display Control Timing Characteristics

Reset Input Timing

 $V_{DD}=5.0\pm10\%$

Parameter	Symbol	Min.	Тур.	Max.	Units
Reset time	t _R	-	-	0.5	ns
Reset "L" Pulse Width	t _{RW}	0.5	-	-	μS

Reset Input Timing

V_{DD}=2.7~4.5V

Parameter	Symbol	Min.	Тур.	Max.	Units
Reset time	t _R	-	-	1	ns
Reset "L" Pulse Width	t _{RW}	1	-	-	μS

Output Timing

V_{DD}=5.0±10%

Parameter	Symbol	Min.	Тур.	Max.	Units
FR Delay Time	t_{DFR}	-	10	40	ns

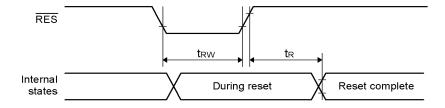
Output Timing

 $V_{DD}=2.7\sim4.5V$

Parameter	Symbol	Min.	Тур.	Max.	Units
FR Delay Time	t _{DFR}	-	20	80	ns

Note 1: Valid only when the master mode is selected.

Note 2:All timing is based on 20% and 80% of Vss.

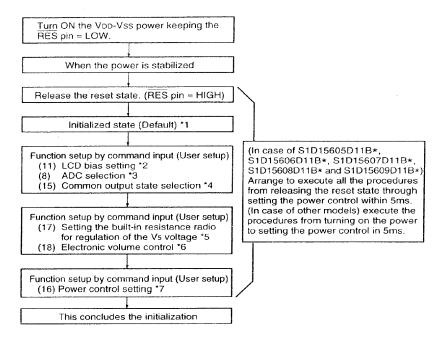


Instruction Setup: Reference (reference)

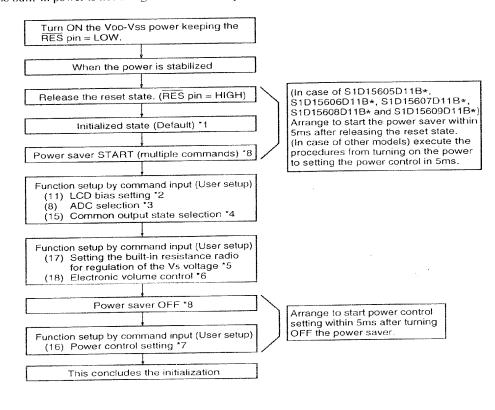
(1) Initialization

Note: With this IC, when the power is applied, LCD driving non-selective potentials V_2 and V_3 (SEG pin) and V_1 and V_4 (COM pin) are output through the LCD driving output pins SEG and COM. When electric charge is remaining in the smoothing capacitor connecting between the LCD driving voltage output pins ($V_1 \sim V_5$) and the V_{DD} pin, the picture on the display may become totally dark instantaneously when the power is turned on. To avoid occurrence of such a failure, we recommend the following flow when turning on the power.

① When the built-in power is being used immediately after turning on the power:



② When the built-in power is not being used immediately after turning on the power:

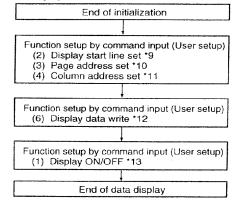


* The target time of 5ms will result to vary depending on the panel characteristics and the capacitance of the smoothing capacitor. Therefore, we suggest you to conduct an operation check using the actual equipment.

Notes: Refer to respective sections or paragraphs listed below.

- *1: 6. Description of functions; "Resetting circuit" (The contents of DDRAM can be variable even in the initial setting (Default) at the reset state.)
- *2: 7. Command description; "(11) LCD bias setting" *3: 7. Command description; "(8) ADC selection"
- *4: 7. Command description; "(15) Common output state selection"
- *5: 6. Description of functions; "Power circuit" & "(17) Command description; Setting the built-in resistance radio for regulation of the V5 voltage"
- 6. Description of functions; "Power circuit" & "(18) Command description; Electronic volume control" 6. Description of functions; "Power circuit" & "(16) Command description; Power control setting"
- 7. The power saver ON state can either be in sleep state or stand-by state. Command description, "Power saver START (multiple commands)"

(2) Data Display

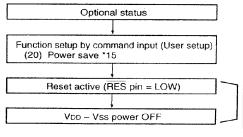


Notes: Reference items

- *9: Command Description; Display start line set
- *10: Command Description; Page address set
- *11: Command Description; Column address set
- *12: Command Description; Display data write
- *13: Command Description; Display ON/OFF Avoid displaying all the data at the data display start (when the display is ON) in white.

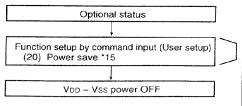
(3) Power OFF *14

In case of S1D15605D11B*, S1D15606D11B*, S1D15607D11B*, S1D15608D11B* and S1D15609D11B*,



Set the time (tL) from reset active to turning off the Voo - Vss power (Voo - Vss = 1.8 V) longer than the time (th) when the potential of V5 ~ V1 becomes below the threshold voltage (approximately 1 V) of the LCD panel. For th, refer to the <Reference Data> of this event. When th is too long, insert a resistor between Vs and Vop to reduce it.

· In case of other models,



Set the time (tL) from power save to turning off the VDD - Vss power (VDD - Vss = 1.8 V) longer than the time (t_H) when the potential of V5 ~ V1 becomes below the threshold voltage (approximately 1V) of the LCD panel.

- th is determined depending on the voltage regulator external resistors Ra and Rb and the time constant of V5 ~ V1 smoothing capacity C2.
- When an internal resistor is used, it is recommended to insert a resistor R between VDD and Vs to reduce th.

Notes: Reference items

- The logic circuit of this IC's power supply VDD VSS controls the driver of the LCD power supply VDD - Vs. So, if the power supply VDD - Vss is cut off when the LCD power supply VDD - Vs has still any residual voltage, the driver (COM, SEG) may output any uncontrolled voltage. When turning off the power, observe the following basic procedures:
 - After turning off the internal power supply, make sure that the potential V5 ~ V1 has become below the threshold voltage of the LCD panel, and then turn off this IC's power supply (VDD - VSS). 6. Description of Function, 6.7 Power Circuit
- *15: After inputting the power save command, be sure to reset the function using the RES terminal until the power supply VDD - Vss is turned off. 7. Command Description (20) Power Save
- *16: After inputting the power save command, do not reset the function using the \overrightarrow{RES} terminal until the power supply VDD - VSS is turned off. 7. Command Description (20) Power Save

(4) Refresh It is recommended that the operating modes and display contents be refreshed periodically to prevent the effect of unexpected noise. Refresh sequence NOP command Set all commands to the ready state (Including default state setting.) Refreshing of DRAM

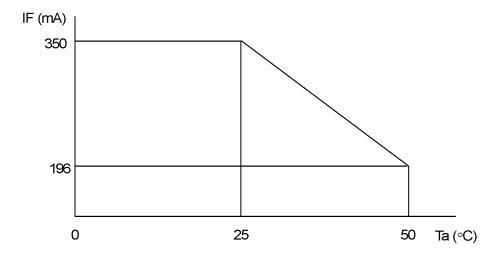
2.4.Lighting Specifications

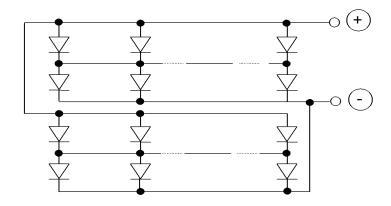
2.4.1.Absolute Maximum Ratings(1Unit)

Ta=25°C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Foward Current	lF	Note 1	-	-	350	mA
Reverse Voltage	VR	-	-	-	8	V
LED Power Dissipation	Po	-	ı	ı	1.61	V

Note 1 : Refer to the foward current derating curve.





2.4.2. Operating Characteristics (1 Chip)

Ta=25°C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Foward Voltage	VF	I _F =25mA	-	4.2	4.6	V
Luminance of	L	I _F =25mA	60.0	-	-	cd/m ²
Backlight Surface						

3. Optical Specifications

3.1.LCD Driving Voltage

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Recommended		Ta= 0°C	-	-	9.7	V
LCD Driving Voltage	V _{DD} -V ₅	Ta=25°C	8.4	9.0	9.6	٧
Note 1		Ta=50°C	8.2	-	-	V

Note 1 : Voltage (Applied actual waveform to LCD Module) for the best contrast. The range of minimum and maximum shows tolerance of the operating voltage. The specified contrast ratio and response time are not guaranteed over the entire range.

3.2. Optical Characteristics

Ta=25°C, 1/65 Duty, 1/7 Bias, V_{OD} =9.0V (Note 4), θ = 0°, ϕ =-°

Ра	rameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Contrast Ra	atio Note 1	CR	θ= 0 °,φ =-°	-	4.5	-	
Viewing An	gle		Shown in 3.3				
Response	Rise Note 2	Ton	-	_	200	300	ms
Time	Decay Note 3	Toff	-	-	90	180	ms

Note 1 :Contrast ratio is definded as follows.(CR = LOFF / LON)

Lon: Luminance of the ON segments

Loff: Luminance of the OFF segments

Measuring Spot:3mm

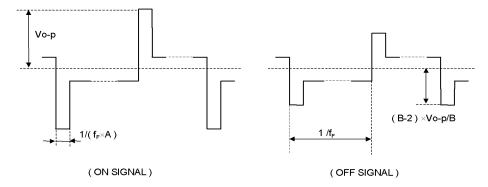
- Note 2 :The time that the luminance level reaches 90% of the saturation level from 0% when ON signal is applied.
- Note 3 :The time that the luminance level reaches 10% of the saturation level from 100% when OFF signal is applied.
- Note 4 : Definition of Driving Voltage Vod

Assuming that the typical driving waveforms shown below are applied to the LCD Panel at 1/A Duty - 1/B Bias (A: Duty Number, B: Bias Number). Driving voltage VoD is definded as follows.

 $V_{OD} = (Vth1+Vth2) / 2$

Vth1: The voltage Vo-P that should provide 70% of the saturation level in the luminance at the segment which the ON signal is applied to.

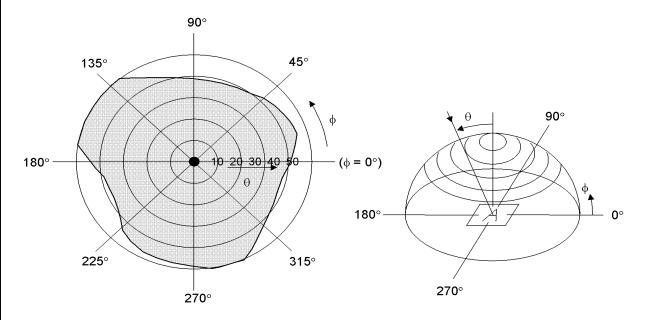
Vth2: The voltage V_{O-P} that should provide 20% of the saturation level in the luminance at the segment which the OFF signal is applied to.



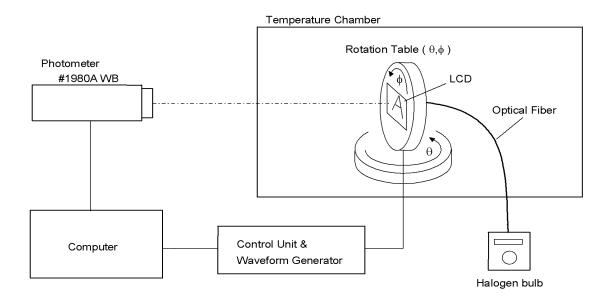
3.3. Definition of Viewing Angle and Optimum Viewing Area

*Point • shows the point where contrast ratio is measured. : θ = 0°, φ = -°

*Driving condition: 1/65 Duty, 1/7 Bias, VoD=9.0V, fF=80Hz



3.4. System Block Diagram

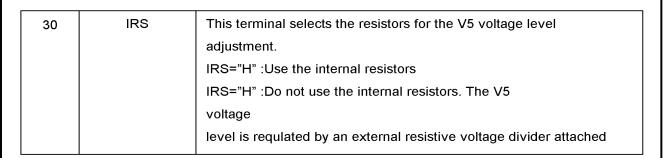


4.<u>I/O Terminal</u>

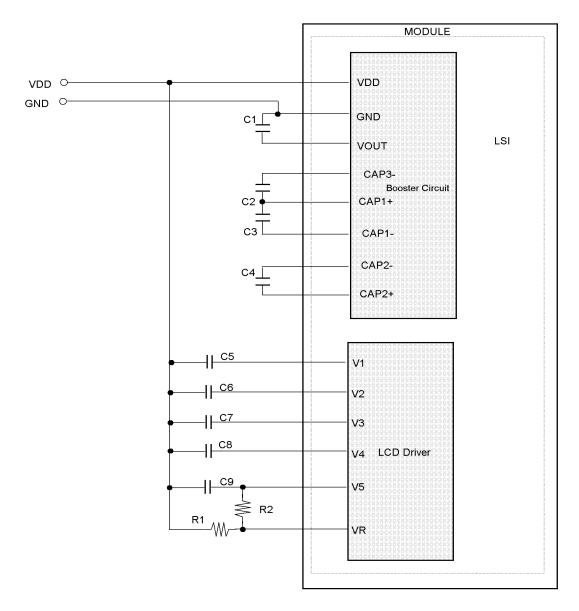
4.1.Pin Assignment

<u>CN1</u>

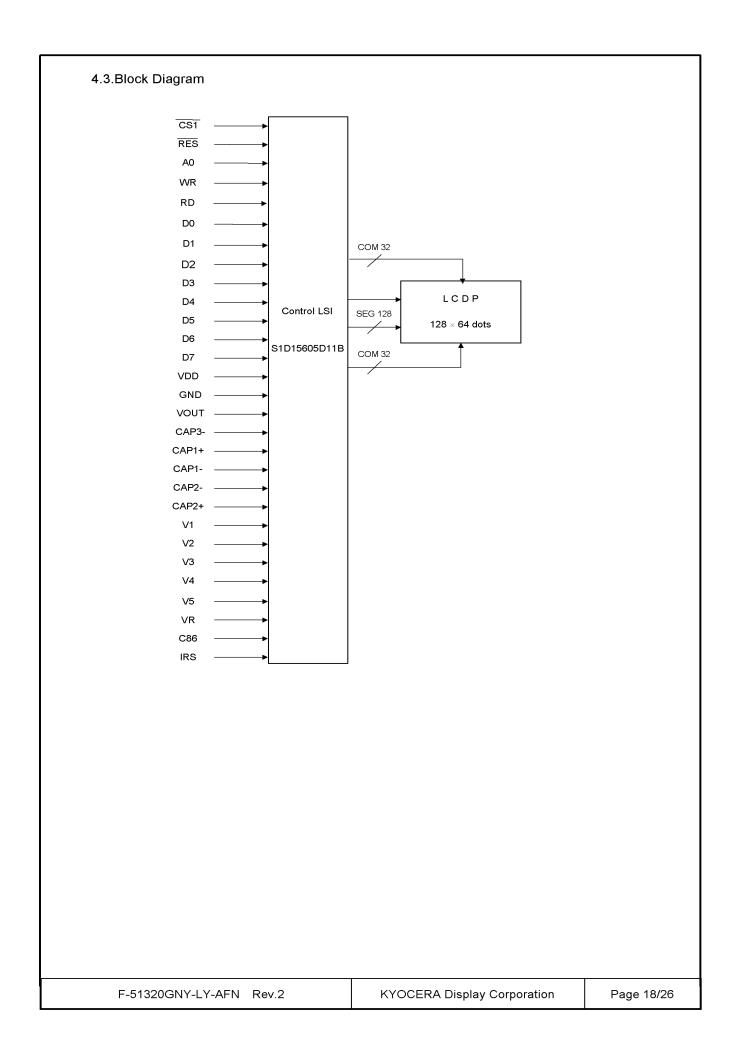
No.	Symbol	Function
1	NC	Non-connection
2	CS1	Chip Select Signal L : Active
3	RES	Reset Signal L : Reset
4	A0	H : D0~D7 are Display Data L : D0~D7 are Instructions
5	WR	Write Signal L : Active
6	RD	Read Signal L : Active
7	D0	Data Bus Line
8	D1	Data Bus Line
9	D2	Data Bus Line
10	D3	Data Bus Line
11	D4	Data Bus Line
12	D5	Data Bus Line
13	D6	Data Bus Line
14	D7	Data Bus Line
15	V _{DD}	Power Supply for Logic
16	GND	Power Supply (0V, GND)
17	Vouт	DC/DC Voltage Converter Output
18	CAP3-	DC/DC Voltage Converter Capacitor 3 Negative Connection
19	CAP1+	DC/DC Voltage Converter Capacitor 1 Positive Connection
20	CAP1-	DC/DC Voltage Converter Capacitor 1 Negative Connection
21	CAP2-	DC/DC Voltage Converter Capacitor 2 Negative Connection
22	CAP2+	DC/DC Voltage Converter Capacitor 2 Positive Connection
23	V ₁	Power Supply for LCD Drive $V_1 = 1/7, V_5$
24	V ₂	Power Supply for LCD Drive $V_2 = 2/7, V_5$
25	Vз	Power Supply for LCD Drive $V_3 = 5/7, V_5$
26	V4	Power Supply for LCD Drive $V_4 = 6/7, V_5$
27	V 5	Power Supply for LCD Drive V₅,Vo∪T
28	VR	Voltage Adjustment Pin
29	C86	Interface Mode Select Signal H : 68 series L : 80 series



4.2. Example of Power Supply



 $\begin{array}{ll} \text{C1\simC4} : 1.0 \mu\text{F}/16\text{V} \\ \text{C5\simC8} : 0.68 \mu\text{F}/16\text{V} \\ \text{R1} : & 270 \text{K}\Omega \pm 0.2\% \\ \text{R2} : & 1.1 \text{M}\Omega \pm 0.2\% \\ \end{array}$



5. Test

No abnormal function and appearance are found after the following tests.

No.	Parameter	Conditions	Notes
1	High Temperature Operating	50°C±2°C, 96hrs (operation state)	1
2	Low Temperature Operating	0°C±2°C, 96hrs (operation state)	2
3	High Temperature Storage	70°C±2°C, 96hrs	3
4	Low Temperature Storage	-20°C±2°C, 96hrs	2, 3
5	Damp Proof Test	40°C±2°C, 90∼95%RH, 96hrs	2, 3
6	Temperature Cycle Test	5 Cycle 1 Cycle 70°C 25°C 30Min 10Min 30Min 10Min The function test snall be conducted after 1 hours storage at the normal temperature and	2
7	Shock Test	To be measured after dropping from 60cm high the concrete surface in packing state. Dropping method corner dropping A corner : once Edge dropping B,C,D edge : once Face dropping E,F,G face : once	

Note 1: It should be checked at the actual driving condition under the high temperature.

Note 2: No dew condensation to be observed.

Note 3 :The function test shall be conducted after 4 hours storage at the normal temperature and humidity after removed from the test chamber.

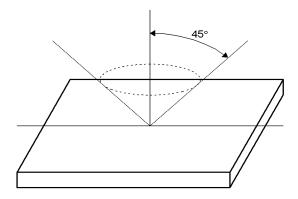
6. Appearance Standards

6.1.Inspection conditions

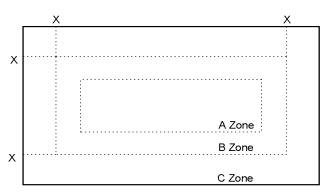
The LCD shall be inspected under 40W white fluorescent light.

The distance between the eyes and the sample shall be more than 30cm.

All directions for inspecting the sample should be within 45° against perpendicular line.



6.2. Definition of applicable Zones



X : Maximum Seal Line

A Zone : Active display area

B Zone : Out of active display area ~ Maximum seal line

C Zone: Rest parts

A Zone + B Zone = Validity viewing area

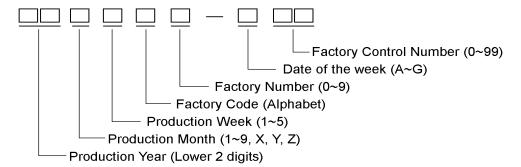
6.3.Standards

No.	Parameter				Criteria			
1	Black and	(1) Round Shape						
	White Spots,		Zone		Acceptable Number			
	Foreign Substances		Dimension ((mm)	Α	В	С	
			D	≤ 0.1	*	*	*	
			0.1 < D	<u>≤</u> 0.2	3	5	*	
			0.2 < D	≤0.25	2	3	*	
			0.25< D	0.3	0	1	*	
			0.3 < 🗅)	0	0	*	
			D = (Long	+ Short) / 2	* : Disrega	rd		
		(2	2) Line Shape	e				
				Zone	Aco	Acceptable Number		
		X (mm) Y (mm)		А	В	С		
			- 0.03 ≥ W		*	*	*	
			2.0 ≥ L	0.05 ≥ W	3	3	*	
			1.0 ≥ L	0.1 ≥ W	3	3	*	
			- 0.1 < W X : Length Y : Width * :		In the same way (1)			
					: Disregard			
		T	otal defects s	shall not exce	ed 5.			
2	Air Bubbles				.			
	(between glass			Zone	Aco	ceptable Num	ber	
	& polarizer)		Dimension ((mm)	Α	В	С	
			D	≤0.3	*	*	*	
			0.3 < D ≤0.4 0.4 < D ≤0.6		3	*	*	
					2	3	*	
			0.6 < D		0	0	*	
			* : Disregard					
		T	otal defects s	shall not exce	ed 3.			

No.	Parameter	Criteria
3	The Shape of Dot	(1) Dot Shape (with Dent)
		0.15≥ As per the sketch of left hand.
		(2) Dot Shape (with Projection)
		Should not be connected to next dot.
		(3) Pin Hole
		$(X+Y) / 2 \le 0.2 mm$ (Less than 0.1 mm is no counted.)
		(4) Deformation
		(X+Y) / 2 ≤ 0.2mm
		Total acceptable number : 1/dot, 5/cell
		(Defect number of (4): 1pc.)
4	Polarizer Scratches	Not to be conspicuous defects.
5	Polarizer Dirts	If the stains are removed easily from LCDP surface, the module is defective.
6	Complex Foreign Substance Defects	Black spots, line shaped foreign substances or air bubbles between glass & polarizer should be 5pcs maximum in total.
7	Distance between Different Foreign Substance Defects	D ≤ 0.2 : 20mm or more 0.2 < D : 40mm or more

7. Code System of Production Lot

The production lot of module is specified as follows.



8. Type Number

The type number of module is specified as follows.

F-51320AF

9. Applying Precautions

Please contact us when questions and/or new problems not specified in this Specifications arise.

10. Precautions Relating Product Handling

The Following precautions will guide you in handling our product correctly.

- 1) Liquid crystal display devices
 - 1. The liquid crystal display panel used in the liquid crystal display module is made of plate glass. Avoid any strong mechanical shock. Should the glass break handle it with care. The polarizer adhering to the surface of the LCD is made of a soft material. Guard against scratching it.
- 2) Care of the liquid crystal display module against static electricity discharge.
 - 1. When working with the module, be sure to ground your body and any electrical equipment you may be using. We strongly recommend the use of anti static mats (made of rubber), to protect worktables against the hazards of electrical shock.
 - 2. Avoid the use of work clothing made of synthetic fibers. We recommend cotton clothing or other conductivity-treated fibers.
 - 3. Slowly and carefully remove the protective film from the LCD module, since this operation can generate static electricity.
- 3) When the LCD module must be stored for long periods of time:
 - 1. Protect the modules from high temperature and humidity.

Conditions: Temperature: 0°C~40°C

Humidity: Less than 60%RH

No dew condensation to be observed.

- 2. Keep the modules out of direct sunlight or direct exposure to ultraviolet rays.
- 3. Protect the modules from excessive external forces.
- 4) Use the module with a power supply that is equipped with an overcurrent protector circuit, since the module is not provided with this protective feature.
- 5) Do not ingest the LCD fluid itself should it leak out of a damaged LCD module. Should hands or clothing come in contact with LCD fluid, wash immediately with soap.
- 6) Conductivity is not guaranteed for models that use metal holders where solder connections between the metal holder and the PCB are not used. Please contact us to discuss appropriate ways to assure conductivity.
- 7) For models which use CFL:
 - 1. High voltage of 1000V or greater is applied to the CFL cable connector area. Care should be taken not to touch connection areas to avoid burns.
 - 2. Protect CFL cables from rubbing against the unit and thus causing the wire jacket to become worn.
 - 3. The use of CFLs for extended periods of time at low temperatures will significantly shorten their service life.
 - 4. After storing the product (or LCD) under low temperature and/or in dark atmosphere for a long period of time, CCFL may take longer time to reach its specified brightness.
- 8) For models which use touch panels:
 - 1.Do not stack up modules since they can be damaged by components on neighboring modules.
 - 2.Do not place heavy objects on top of the product. This could cause glass breakage.

- 9) For models which use COG, TAB, or COF:
 - 1. The mechanical strength of the product is low since the IC chip faces out unprotected from the rear. Be sure to protect the rear of the IC chip from external forces.
 - 2. Given the fact that the rear of the IC chip is left exposed, in order to protect the unit from electrical damage, avoid installation configurations in which the rear of the IC chip runs the risk of making any electrical contact.
- 10) Models which use flexible cable, heat seal, or TAB:
 - 1.In order to maintain reliability, do not touch or hold by the connector area.
- 2. Avoid any bending, pulling, or other excessive force, which can result in broken connections.
- 11)In case of buffer material such as cushion / gasket is assembled into LCD module, it may have an adverse effect on connecting parts (LCD panel-TCP / HEAT SEAL / FPC / etc., PCB-TCP / HEAT SEAL / FPC etc., TCP-HEAT SEAL, TCP-FPC, HEAT SEAL-FPC, etc.,) depending on its materials. Please check and evaluate these materials carefully before use.
- 12)In case of acrylic plate is attached to front side of LCD panel, cloudiness (very small cracks) can occur on acrylic plate, being influenced by some components generated from polarizer film. Please check and evaluate those acrylic materials carefully before use.

11. Warranty

This product has been manufactured to your company's specifications as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery pecifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in medical devices, nuclear power control equipment, aerospace equipment, fire and security systems, or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required. If the product is to be used in any of the above applications, we will need to enter into a separate product liability agreement.

- 1. We cannot accept responsibility for any defect, which may arise from additional manufacturing of the product (including disassembly and reassembly), after product delivery.
- 2. We cannot accept responsibility for any defect, which may arise after the application of strong external force to the product.
- 3. We cannot accept responsibility for any defect, which may arise due to the application of static electricity after the product has passed your company's acceptance inspection procedures.
- 4. When the product is in CFL models, CFL service life and brightness will vary according to the performance of the inverter used, leaks, etc. We cannot accept responsibility for product performance, reliability, or defect, which may arise.
- 5. We cannot accept responsibility for intellectual property of a third party, which may arise through the application of our product to your assembly with exception to those issues relating directly to the structure or method of manufacturing of our product.
- 6. We will not be held responsible for any quality issue(s) after two years and beyond from its production date indicated on the lot number (please refer to "Code System of Production Lot" indicated earlier in this specification).

Mouser Electronics

Authorized Distributor

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Kyocera:

F-51320GNY-LY-AFN